imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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July 2016

Chip beads

For power line

MPZ series (for automobiles)

MPZ2012 Type

MPZ2012

2012[0805 inch]*

* Dimensions code JIS[EIA]

Reminders for using these products

Before using these products, be sure to request the delivery specifications.

Safety reminders

Please pay sufficient attention to the warnings for safe designing when using this products.

⚠ Reminders				
The storage period is less than 12 months. Be sure to follow the storage conditions (temperature:5 to 40°C, humidity:10 to 75% RH c less).				
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.				
\bigcirc Do not use or store in locations where there are conditions such	n as gas corrosion (salt, acid, alkali, etc.).			
 Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperators does not exceed 150°C. 	ture difference between the solder temperature and chip temperature			
 Soldering corrections after mounting should be within the range If overheated, a short circuit, performance deterioration, or lifes 				
When embedding a printed circuit board where a chip is mount the overall distortion of the printed circuit board and partial distortion	ted to a set, be sure that residual stress is not given to the chip due to prtion such as at screw tightening portions.			
 Self heating (temperature increase) occurs when the power is design. 	turned ON, so the tolerance should be sufficient for the set thermal			
 Carefully lay out the coil for the circuit board design of the non-n A malfunction may occur due to magnetic interference. 	nagnetic shield type.			
\bigcirc Use a wrist band to discharge static electricity in your body through the static electricity in your body through the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity in your body through the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity in your body through the static electricity is the static electricity electricity is the static electricity elec	ugh the grounding wire.			
\bigcirc Do not expose the products to magnets or magnetic fields.				
\bigcirc Do not use for a purpose outside of the contents regulated in the	e delivery specifications.			
ment, home appliances, amusement equipment, computer equipment, industrial robots) under a normal operation and use cond The products are not designed or warranted to meet the required ity require a more stringent level of safety or reliability, or whose person or property.	neral electronic equipment (AV equipment, telecommunications equip- uipment, personal equipment, office equipment, measurement equip- ition. ments of the applications listed below, whose performance and/or qual- e failure, malfunction or trouble could cause serious damage to society, or or if you have special requirements exceeding the range or conditions			
 (1) Aerospace/aviation equipment (2) Transportation equipment (electric trains, ships, etc.) (3) Medical equipment (4) Power-generation control equipment (5) Atomic energy-related equipment (6) Seabed equipment (7) Transportation control equipment 	 (8) Public information-processing equipment (9) Military equipment (10) Electric heating apparatus, burning equipment (11) Disaster prevention/crime prevention equipment (12) Safety equipment (13) Other applications that are not considered general-purpose applications 			
When designing your equipment even for general-purpose applica tection circuit/device or providing backup circuits in your equipmen	tions, you are kindly requested to take into consideration securing pro- t.			

⊗TDK

Chip beads

For power line

Product compatible with RoHS directive Halogen-free Compatible with lead-free solders AEC-Q200

Overview of MPZ2012 type

FEATURES

○ Noise reduction solution for power line.

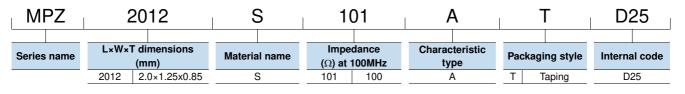
O Compared to the MMZ series, has low direct current resistance for compatibility with large currents, optimal for low power consumption.

O Performs well even in signal lines where low direct current resistance is required.

APPLICATION

Various ECUs, powertrains, body controls, and car multimedia (telematics).

PART NUMBER CONSTRUCTION



OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

	Temperatu	ure ranges	Package quantity	Individual weight
Туре	Operating temperature	Storage temperature*		
	(°C)	(°C)	(pieces/reel)	(mg)
MPZ2012	-55 to +125	-55 to +125	4,000	8
	r			

* The storage temperature range is for after the circuit board is mounted.

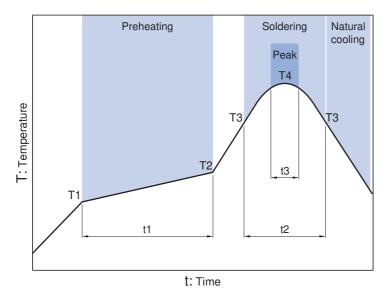
OROHS Directive Compliant Product: See the following for more details.https://product.tdk.com/info/en/environment/rohs/index.html

O Halogen-free: indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.

Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

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RECOMMENDED REFLOW PROFILE



Preheatin	g		Soldering	l	Peak	
Temp.		Time	Temp.	Time	Temp.	Time
T1	T2	t1	Т3	t2	T4	t3
150°C	180°C	60 to 120s	230°C	30 to 60s	250 to 260°C	10s

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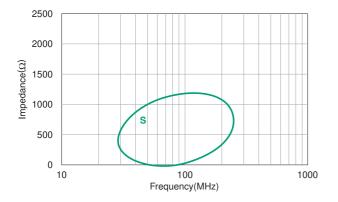
EMC Components

MPZ2012 type

MATERIAL CHARACTERISTIC

S material: Standard type that features impedance characteristics similar to those of a typical ferrite core. For signal line applications in which the blocking region is near 100MHz. Impedance values selected for effectiveness at 40 to 300MHz.

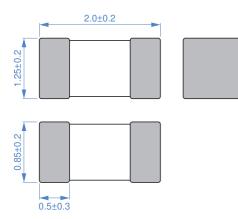
TYPICAL MATERIAL IMPEDANCE CHARACTERISTICS



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MPZ2012 type

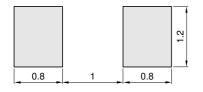
SHAPE & DIMENSIONS





Dimensions in mm

RECOMMENDED LAND PATTERN



Dimensions in mm

MPZ2012 type

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

Impedance		DC resistance	Rated current*	Part No.
[100MHz]				
(Ω)	Tolerance	(Ω) max.	(A)max.	
30	±10Ω	0.010	6	MPZ2012S300ATD25
100	±25%	0.020	4	MPZ2012S101ATD25
220	±25%	0.040	3	MPZ2012S221ATD25
330	±25%	0.050	2.5	MPZ2012S331ATD25
600	±25%	0.100	2	MPZ2012S601ATD25
1000	±25%	0.150	1.5	MPZ2012S102ATD25

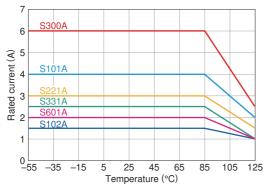
* Please refer to the graph of rated current vs. temperature characteristics (derating) about the rating current at 85°C or more in temperature of the product.

O Measurement equipment

Measurement item	Product No.	Manufacturer
Impedance	E4991A+16192A	Keysight Technologies
DC resistance	Type-7556	Yokogawa

* Equivalent measurement equipment may be used.

○ Rated current vs. temperature characteristics (derating)

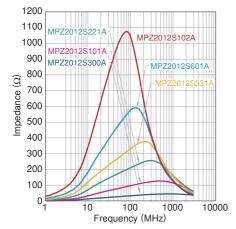


MPZ2012 type

ELECTRICAL CHARACTERISTICS

□ Z VS. FREQUENCY CHARACTERISTICS (BY SERIES)

MPZ2012S series



A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

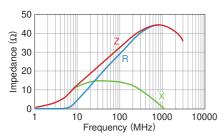
⊗TDK

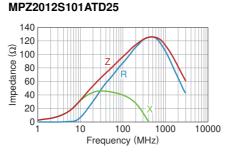
MPZ2012 type

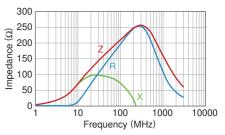
ELECTRICAL CHARACTERISTICS

Z, X, R VS. FREQUENCY CHARACTERISTICS

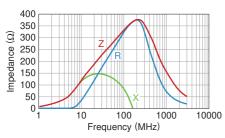
MPZ2012S300ATD25



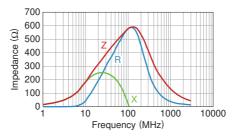




MPZ2012S331ATD25

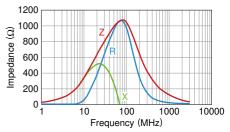


MPZ2012S601ATD25



MPZ2012S102ATD25

MPZ2012S221ATD25



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⊗TDK

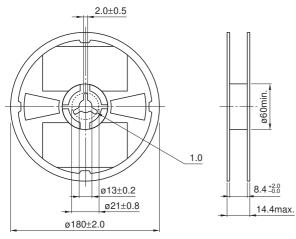
⊗TDK

EMC Components

MPZ2012 type

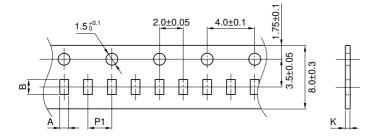
PACKAGING STYLE

REEL DIMENSIONS

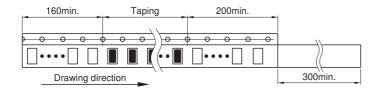


Dimensions in mm

TAPE DIMENSIONS



Dimensions in m				
Туре	A	В	P1	K
MPZ2012	1.5±0.2	2.3±0.2	4.0±0.1	1.1max.



Dimensions in mm